

CM1211FB TYPE

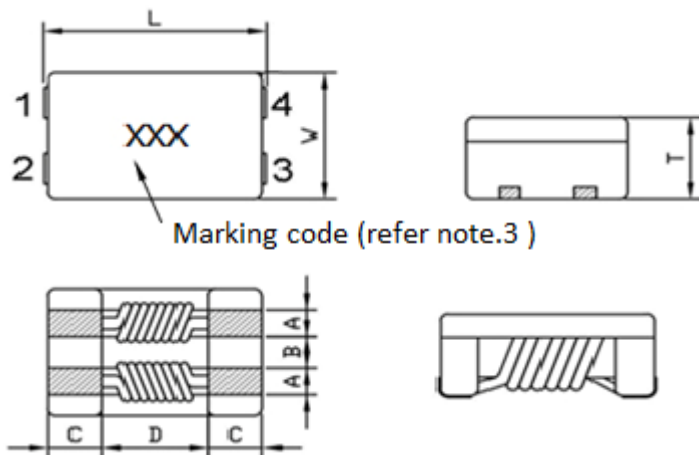
●FEATURE

1. Capable of handling the highest current of any chip-type common mode filter.
2. Noise is greatly suppressed.

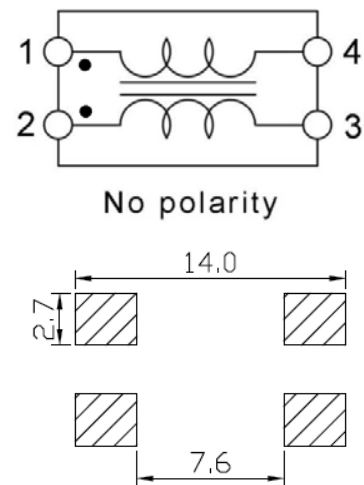
●Applications

1. Used for power line noise suppression for any electric devices. Used to counter adapter/battery line noise for relatively large electronic devices such as notebook , stand-alone word processor, etc.

●Shape and Dimension



●Schematics and Land Patterns(mm)



L=12.5±0.50 m/m ; W=10.8±0.50 m/m ; T=6.40 m/m Max ;

A=2.70±0.50 m/m ; B=2.50±0.50 m/m ; C=2.50±0.50 m/m; D=7.00m/m REF.

●Specification

Part number	Common mode Impedance Z(Ω) at 100MHz		DC Resistance (mΩ Max)	Rated Current(A)	Rated Voltage(V)	Insulation Resistance (MΩ)Min
	min	typical				
CM1211FB-800-1T	80	130	2.0	10.0	125	10
CM1211FB-501-3T	300	500	5.5	8.0	125	10
CM1211FB-701-4T	500	700	6.0	8.0	125	10
CM1211FB-801-4T	600	800	8.0	8.0	125	10
CM1211FB-102-5T	750	1000	14.0	6.0	125	10

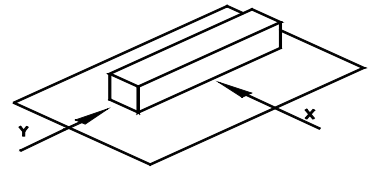
Note1. Measurement ambient temperature of Impedance, DCR and IDC : at 25°C

Note2. Packing: reel ; Quantity: 500pcs/reel

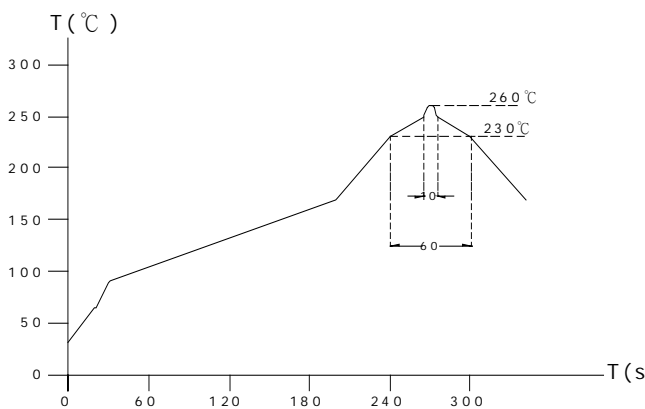
Note3. The first letter is called start winding.(ex. 701 code, 7 is called start winding)

GENERAL CHARACTERISTICS

1. Operating temperature range: -40 TO + 125°C(Includes temperature when the coil is heated)
2. External appearance: On visual inspection, the coil has no external defects.
3. Terminal strength: After soldering. Between copper plate and terminals of coil. Push in two directions of X.Y withstanding at below conditions.
Terminal should not peel off. (refer to figure at right) 5. 0N 60 sec.
4. Insulating resistance: Over 100MΩ at 100V D.C. between coil and core.
5. Dielectric strength: No dielectric breakdown at 100V D.C. for 1 minute between coil and core.
6. Temperature characteristics: Inductance coefficient $(0\sim 2,000)\times 10^{-6}/^{\circ}\text{C}$ (-25~+80°C) , inductance deviation within $\pm 5.0\%$, after 96 hours
7. Humidity characteristics(Moisture Resistance): Inductance deviation within $\pm 5\%$, after 96 hours in 90~95% relative humidity at $40 \pm 2^{\circ}\text{C}$ and 1 hour drying under normal condition.
8. Vibration resistance: Inductance deviation within $\pm 5\%$, after vibration for 1 hour. In each of three orientations at sweep vibration (10~55~10 Hz) with 1.5mm P-P amplitudes.
9. Shock resistance: Inductance deviation within $\pm 5\%$, after being dropped once with 981m/s² (100G) shock attitude upon a rubber block method shock testing machine, in three different orientations.
10. Resistance to Soldering Heat: 260°C, 10 seconds(See attached recommend reflow)
11. Storage condition: Temperature Range: 0°C ~ 35°C ; -40°C ~ 125°C (after PCB) · Humidity Range: 50% ~ 70% RH
12. Use components within 12 months. If 12 months or more have elapsed, check solderability before use.
13. Reflow profile recommend:



Lead-free heat endurance test



Lead-free the recommended reflow condition

